

Global Integrated Circuits (IC) Packaging & Testing Market Growth (Status and Outlook) 2026-2032

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Abstracts

The global Integrated Circuits (IC) Packaging & Testing market size is predicted to grow from US\$ 95860 million in 2025 to US\$ 136150 million in 2032; it is expected to grow at a CAGR of 5.2% from 2026 to 2032.

A process wherein a semiconductor chip is packaged in a form suitable for the electronic device.

Semiconductor packaging is a process of protecting the chip from the external environment, and electrically packaging it to connect the terminals. The integrated circuit (IC) is a component of circuit boards and electronic devices. ICs need to be electrically packaged in a form fitting to where they're installed. They are responsible for interconnects, supplying electrical power, and heat dissipation. Packaging also protects the semiconductor chips, shielding the integrated circuits from external factors such as high temperatures, impurities, and physical impact. Each chip is tested to verify normal operation after the packaging process has been completed. This testing is called the package test. The package test is conducted on finished chip products. Chips are placed in a testing apparatus and tested under various conditions to sort out defective products.

The semiconductor industry chain mainly includes three major processes: chip design, chip manufacturing, and packaging and testing. According to the different business models of packaging and testing companies, the business model is divided into two types: IDM and OSAT.

This report studies the Integrated Circuits (IC) Packaging and Testing Service.

The key IDMs include Samsung-Memory, Intel, SK Hynix, Micron Technology, Texas Instruments (TI), STMicroelectronics, Kioxia, Sony Semiconductor Solutions Corporation (SSS), Infineon, NXP, Analog Devices, Inc. (ADI), Renesas Electronics, Microchip Technology and Onsemi; and the key OSATs include ASE (SPIL), Amkor, JCET (STATS ChipPAC), Tongfu Microelectronics (TFME), Powertech Technology Inc. (PTI), Carsem, King Yuan Electronics Corp. (KYEC), SFA Semicon, Unisem Group, Chipbond Technology Corporation and ChipMOS TECHNOLOGIES, etc.

Following a strong growth of 26.2 percent in the year 2021, WSTS revised it down to a single digit growth for the worldwide semiconductor market in 2022 with a total size of US\$580 billion, up 4.4 percent. WSTS lowered growth estimation as inflation rises and end markets seeing weaker demand, especially those exposed to consumer spending. While some major categories are still double-digit year-over-year growth in 2022, led by Analog with 20.8 percent, Sensors with 16.3 percent, and Logic with 14.5 percent growth. Memory declined with 12.6 percent year over year. In 2022, all geographical regions showed double-digit growth except Asia Pacific. The largest region, Asia Pacific, declined 2.0 percent. Sales in the Americas were US\$142.1 billion, up 17.0% year-on-year, sales in Europe were US\$53.8 billion, up 12.6% year-on-year, and sales in Japan were US\$48.1 billion, up 10.0% year-on-year. However, sales in the largest Asia-Pacific region were US\$336.2 billion, down 2.27% year-on-year.

LPI (LP Information)' newest research report, the “Integrated Circuits (IC) Packaging & Testing Industry Forecast” looks at past sales and reviews total world Integrated Circuits (IC) Packaging & Testing sales in 2025, providing a comprehensive analysis by region and market sector of projected Integrated Circuits (IC) Packaging & Testing sales for 2026 through 2032. With Integrated Circuits (IC) Packaging & Testing sales broken down by region, market sector and sub-sector, this report provides a detailed analysis in US\$ millions of the world Integrated Circuits (IC) Packaging & Testing industry.

This Insight Report provides a comprehensive analysis of the global Integrated Circuits (IC) Packaging & Testing landscape and highlights key trends related to product segmentation, company formation, revenue, and market share, latest development, and M&A activity. This report also analyses the strategies of leading global companies with a focus on Integrated Circuits (IC) Packaging & Testing portfolios and capabilities, market entry strategies, market positions, and geographic footprints, to better understand these firms' unique position in an accelerating global Integrated Circuits (IC) Packaging & Testing market.

This Insight Report evaluates the key market trends, drivers, and affecting factors

shaping the global outlook for Integrated Circuits (IC) Packaging & Testing and breaks down the forecast by Business Model, by Application, geography, and market size to highlight emerging pockets of opportunity. With a transparent methodology based on hundreds of bottom-up qualitative and quantitative market inputs, this study forecast offers a highly nuanced view of the current state and future trajectory in the global Integrated Circuits (IC) Packaging & Testing.

This report presents a comprehensive overview, market shares, and growth opportunities of Integrated Circuits (IC) Packaging & Testing market by product type, application, key players and key regions and countries.

Segmentation by Business Model:

IDM

OSAT

Segmentation by Application:

Analog IC Packaging & Testing

MPU & MCUs IC Packaging & Testing

Logic IC Packaging & Testing

Memory IC Packaging & Testing

This report also splits the market by region:

Americas

United States

Canada

Mexico

Brazil

APAC

China

Japan

Korea

Southeast Asia

India

Australia

Europe

Germany

France

UK

Italy

Russia

Middle East & Africa

Egypt

South Africa

Israel

Turkey

GCC Countries

The below companies that are profiled have been selected based on inputs gathered from primary experts and analyzing the company's coverage, product portfolio, its market penetration.

Samsung

Intel

SK Hynix

Micron Technology

Texas Instruments (TI)

STMicroelectronics

Kioxia

Western Digital

Infineon

NXP

Analog Devices, Inc. (ADI)

Renesas

Microchip Technology

Onsemi

Sony Semiconductor Solutions Corporation

Panasonic

Winbond

Nanya Technology

ISSI (Integrated Silicon Solution Inc.)

Macronix

Giantec Semiconductor

Sharp

Magnachip

Toshiba

JS Foundry KK.

Hitachi

Murata

Skyworks Solutions Inc

Wolfspeed

Littelfuse

Diodes Incorporated

Rohm

Fuji Electric

Vishay Intertechnology

Mitsubishi Electric

Nexperia

Ampleon

CR Micro

Hangzhou Silan Integrated Circuit

ASE (SPIL)

Amkor

JCET (STATS ChipPAC)

Tongfu Microelectronics (TFME)

Powertech Technology Inc. (PTI)

Carsem

King Yuan Electronics Corp. (KYEC)

SFA Semicon

Unisem Group

Chipbond Technology Corporation

ChipMOS TECHNOLOGIES

OSE CORP.

Sigurd Microelectronics

Natronix Semiconductor Technology

Nepes

Forehope Electronic (Ningbo) Co.,Ltd.

Union Semiconductor?Hefei?Co., Ltd.

Hefei Chipmore Technology Co.,Ltd.

HT-tech

Chippacking

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